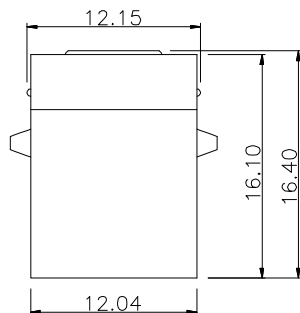
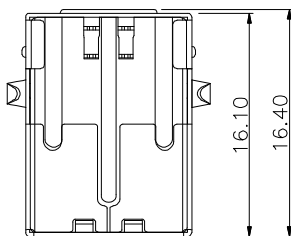
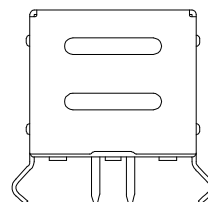
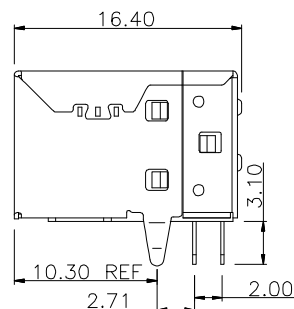
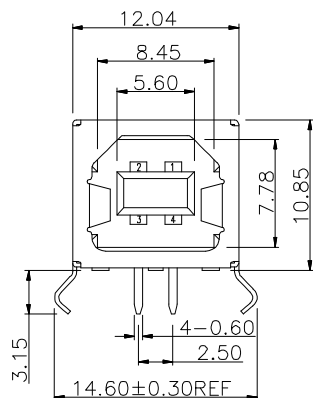


Recommended P.C.B Layout
TOLERANCE ± 0.05 (COMPONENT SIDE)



MATERIALS

HOUSING: THERMOPLASTICS BLACK OR WHITE(UL 94V-0)
SHELL: COPPER ALLOY OR SPCC, NICKEL PLATING
TERMINAL: COPPER ALLOY, GOLD PLATED ON CONTACT AREA
TIN PLATING ON SOLDER TAIL

SPECIFICATION

CURRENT RATING: 1.5 AMP MAX
DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE
CONTACT RESISTANCE: 30m OHMS MAX
INSULATION RESISTANCE: 1000M OHMS MIN AT DC 500V
OPERATION TEMPERATURE: -55°C~+85°C



PART NO.:

UBF-041R X P X -CF1066

G :GOLD FLASH
I : 30u" GOLD

SHELL MATERIALS:
Blank:COPPER ALLOY
3:SPCC

HOUSING COLOR:
B:BLACK
W:WHITE



CHERNG WEEI

承洧科技股份有限公司
Cherng Wee Technology Corp.

DESCRIPTION(內容):

USB TYPE B 90° DIP 母
(RoHS)

PART NO:
(料 號) UBF-041RXPX_-CF1066

DWG NO(圖號): 22BF-04XT-117LXX

DRAWN(製圖):

ZHANG

CHECKED(確認):

TERESA

APPROVAL(核准):

JOHNNY

GENERAL TOLERANCE:

(公差) .X ± 0.30
.XX ± 0.20
.XXX ± 0.10
ANGLE $\pm 3^\circ$

SCALE(比例):

FREE



REV:

R4

UNIT:

mm

SIZE:

A4

SHEET:

1/1

REV

R0

R1

R2

R3

R4

DESCRIPTION

圖面更新
圖面更新(新增尺寸(A))
圖面更新
圖面更新

DATE

2018.02.07
2020.12.23
2021.01.14
2025.06.06
2025.06.23

A

B

C

D

E

CF1066